RENESAS

PHOTOCOUPLER
PS9122

1 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5) HIGH-SPEED PHOTOCOUPLER

–NEPOC Series–

DESCRIPTION

The PS9122 is an optical coupled high-speed, active low type isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9122 is a high-speed digital output type photocoupler designed specifically for low circuit current.

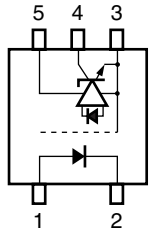
The PS9122 is in 5-pin plastic SOP (Small Outline Package) and is suitable for high density application.

FEATURES

- Supply Voltage
  N rank: V_{CC} = 3.3 V
  L rank: V_{CC} = 5 V
- Pulse width distortion ($|t_{PHL} - t_{PLH}|$ = 200 ns MAX.)
- Small package (SO-5)
- High-speed (1 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Open collector output
- Embossed tape product: PS9122-F3: 2 500 pcs/reel
- Pb-Free product

<R>
- Safety standards
  - UL approved: File No. E72422
  - DIN EN60747-5-2 (VDE0884 Part2) approved No.40008902 (option)

PIN CONNECTION
(Top View)



1. Anode
2. Cathode
3. GND
4. V_O
5. V_{CC}

TRUTH TABLE

LED	Output
ON	L
OFF	H

APPLICATIONS

- PoE (Power over Ethernet)
- Measurement equipment
- FA Network

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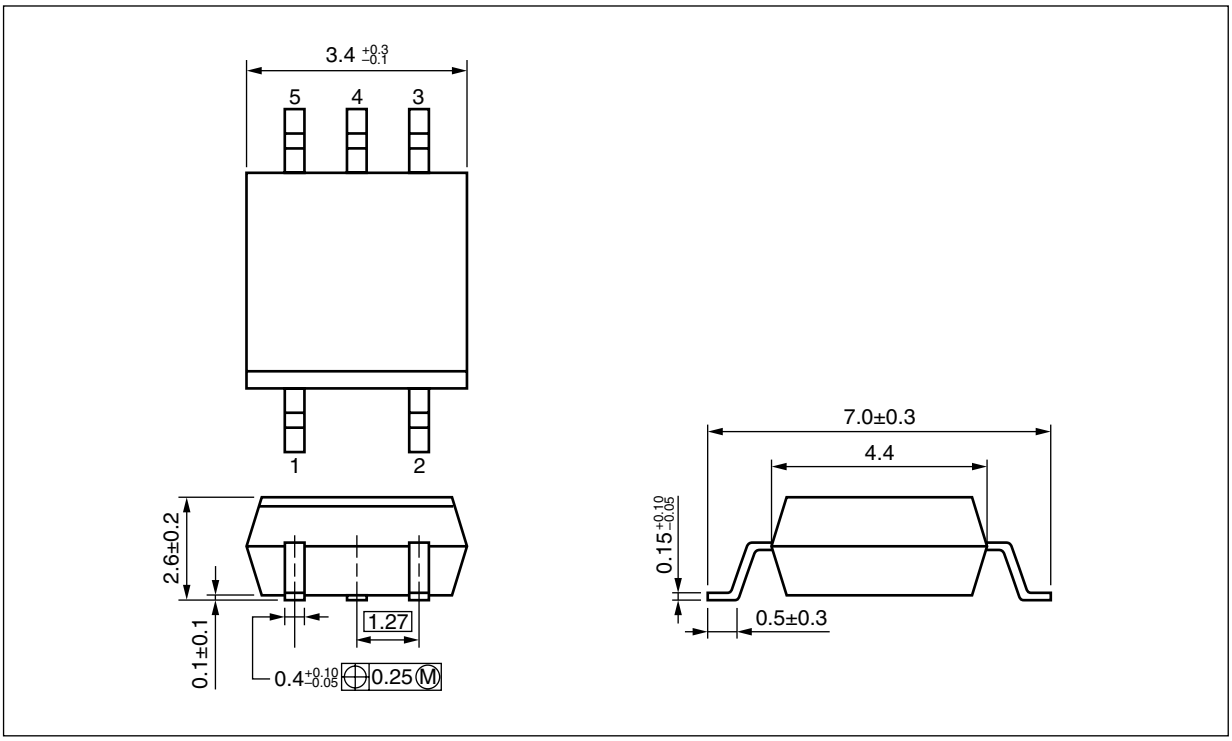
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Date Published March 2010 NS
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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)

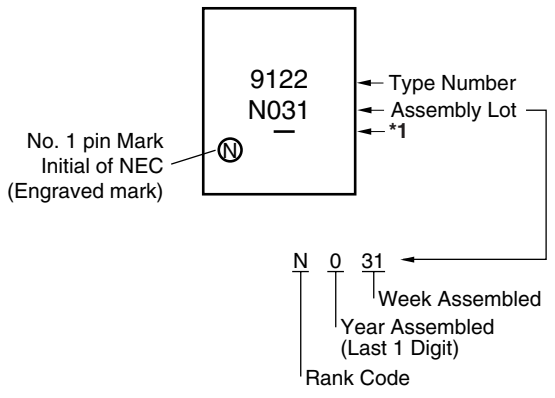


<R> PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	4.2 mm
Outer Creepage Distance	4.2 mm
Isolation Distance	0.2 mm

<R> MARKING EXAMPLE

Ni/Pd/Au PLATING



***1** Bar : Pb-Free

<R> **ORDERING INFORMATION**

Part Number	Order Number	Rank	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number*1
PS9122	PS9122-AX	N*2	Pb-Free (Ni/Pd/Au)	20 pcs (Tape 20 pcs cut)	Standard products (UL approved)	PS9122
		L*3				
PS9122-F3	PS9122-F3-AX	N*2		Embossed Tape 2 500 pcs/reel		
		L*3				
PS9122-V	PS9122-V-AX	N*2		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2 (VDE0884 Part2) approved (Option)	
		L*3				
PS9122-V-F3	PS9122-V-F3-AX	N*2		Embossed Tape 2 500 pcs/reel		
		L*3				

***1** For the application of the Safety Standard, following part number should be used.

***2** N rank: V_{CC} = 3.3 V

***3** L rank: V_{CC} = 5 V

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current*1	I_F	25	mA
	Reverse Voltage	V_R	5	V
Detector	Supply Voltage	V_{CC}	7	V
	Output Voltage	V_O	7	V
<R>	Output Current	I_O	20	mA
	Power Dissipation*2	P_C	40	mW
Isolation Voltage*3		BV	3 750	Vr.m.s.
Operating Ambient Temperature		T_A	–40 to +100	°C
Storage Temperature		T_{stg}	–55 to +125	°C

<R> ***1** Reduced to 0.17 mA/°C at T_A = 25°C or more.

<R> ***2** Applies to output pin V_O (collector pin). Reduced to 1.5 mW/°C at T_A = 80°C or more.

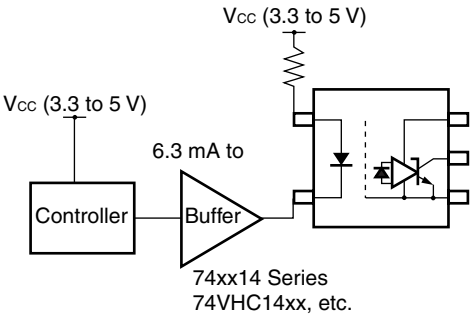
***3** AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-2 shorted together, 3-5 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter		Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage		V_{FL}	0		0.8	V
High Level Input Current		I_{FH}	6.3	10	12.5	mA
Supply Voltage	N rank	V_{CC}	2.7	3.3	3.6	V
	L rank		4.5	5.0	5.5	
<R> TTL (R_L = 1 kΩ, loads)		N			3	
Pull-up Resistor		R_L	330		4 k	Ω

<R> DRIVER CIRCUIT

It is recommended to use some buffer for low output current controller, especially in the case of low V_{CC}, otherwise to confirm that enough input current is supplied from controller.



ELECTRICAL CHARACTERISTICS 1: N rank (T_A = –40 to +100°C, unless otherwise specified)

	Parameter		Symbol	Conditions	MIN.	TYP.[*1]	MAX.	Unit
	Diode	Forward Voltage	V_F	I_F = 10 mA, T_A = 25°C		1.6	1.8	V
		Reverse Current	I_R	V_R = 3 V, T_A = 25°C			10	μA
		Terminal Capacitance	C_t	V = 0 V, f = 1 MHz, T_A = 25°C		30		pF
	Detector	High Level Output Current	I_{OH}	V_{CC} = V_O = 3.3 V, V_F = 0.8 V		1	100	μA
<R>		Low Level Output Voltage[*2]	V_{OL}	V_{CC} = 3.3 V, I_F = 5 mA, I_{OL} = 10 mA		0.2	0.6	V
		High Level Supply Current	I_{CCH}	V_{CC} = 3.3 V, I_F = 0 mA, V_O = Open			2	mA
		Low Level Supply Current	I_{CCL}	V_{CC} = 3.3 V, I_F = 10 mA, V_O = Open			3	
<R>	Coupled	Threshold Input Current (H → L)	I_{FHL}	V_{CC} = 3.3 V, V_O = 0.8 V, R_L = 350 Ω		2	5	mA
		Isolation Resistance	R_{I-O}	V_{I-O} = 1 kV_{DC}, RH = 40 to 60%, T_A = 25°C	10^{11}			Ω
		Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz, T_A = 25°C		0.6		pF
		Propagation Delay Time (H → L)[*3]	t_{PHL}	V_{CC} = 3.3 V, R_L = 350 Ω, I_F = 7.5 mA, V_{THHL} = V_{THLH} = 1.5 V			500	ns
		Propagation Delay Time (L → H)[*3]	t_{PLH}				700	
<R>		Rise Time	t_r			60		ns
<R>		Fall Time	t_f			70		
		Pulse Width Distortion (PWD)[*3]	$\lvert t_{PHL}-t_{PLH} \rvert$				200	ns
<R>		Common Mode Transient Immunity at High Level Output[*4]	CM_H	V_{CC} = 3.3 V, R_L = 350 Ω, T_A = 25°C, I_F = 0 mA, V_O > 2.0 V, V_{CM} = 1.0 kV	15	20		kV/μs
<R>		Common Mode Transient Immunity at Low Level Output[*4]	CM_L	V_{CC} = 3.3 V, R_L = 350 Ω, T_A = 25°C, I_F = 7.5 mA, V_O < 0.8 V, V_{CM} = 1.0 kV	15	20		

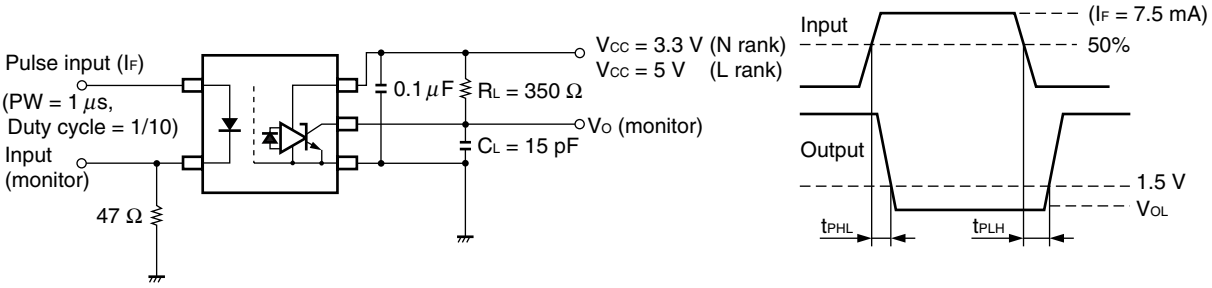
ELECTRICAL CHARACTERISTICS 2: L rank (T_A = –40 to +100°C, unless otherwise specified)

	Parameter		Symbol	Conditions	MIN.	TYP.[*5]	MAX.	Unit
	Diode	Forward Voltage	V_F	I_F = 10 mA, T_A = 25°C		1.6	1.8	V
		Reverse Current	I_R	V_R = 3 V, T_A = 25°C			10	μA
		Terminal Capacitance	C_t	V = 0 V, f = 1 MHz, T_A = 25°C		30		pF
	Detector	High Level Output Current	I_{OH}	V_{CC} = V_O = 5 V, V_F = 0.8 V		1	100	μA
		Low Level Output Voltage[*6]	V_{OL}	V_{CC} = 5 V, I_F = 5 mA, I_{OL} = 13 mA		0.2	0.6	V
		High Level Supply Current	I_{CCH}	V_{CC} = 5 V, I_F = 0 mA, V_O = Open			2.5	mA
		Low Level Supply Current	I_{CCL}	V_{CC} = 5 V, I_F = 10 mA, V_O = Open			3.5	
<R>	Coupled	Threshold Input Current (H → L)	I_{FHL}	V_{CC} = 5 V, V_O = 0.8 V, R_L = 350 Ω		2	5	mA
		Isolation Resistance	R_{I-O}	V_{I-O} = 1 kV_{DC}, RH = 40 to 60%, T_A = 25°C	10^{11}			Ω
		Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz, T_A = 25°C		0.6		pF
		Propagation Delay Time (H → L)[*7]	t_{PHL}	V_{CC} = 5 V, R_L = 350 Ω, I_F = 7.5 mA, V_{THHL} = V_{THLH} = 1.5 V			500	ns
		Propagation Delay Time (L → H)[*7]	t_{PLH}				700	
<R>		Rise Time	t_r			60		ns
<R>		Fall Time	t_f			70		
		Pulse Width Distortion (PWD)[*7]	$\lvert t_{PHL}-t_{PLH} \rvert$				200	ns
<R>		Common Mode Transient Immunity at High Level Output[*8]	CM_H	V_{CC} = 5 V, R_L = 350 Ω, T_A = 25°C, I_F = 0 mA, V_O > 2.0 V, V_{CM} = 1.0 kV	15	20		kV/μs
<R>		Common Mode Transient Immunity at Low Level Output[*8]	CM_L	V_{CC} = 5 V, R_L = 350 Ω, T_A = 25°C, I_F = 7.5 mA, V_O < 0.8 V, V_{CM} = 1.0 kV	15	20		

***1, 5.** Typical values at T_A = 25°C

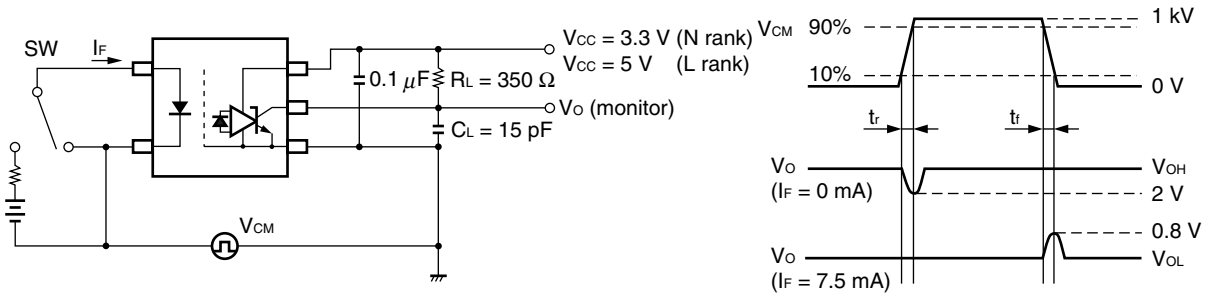
<R> ***2, 6.** Because V_{OL} of 2 V or more may be output when LED current input and when output supply of V_{CC} = 2 V more or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.

<R> ***3, 7.** Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

<R> ***4, 8.** Test circuit for common mode transient immunity



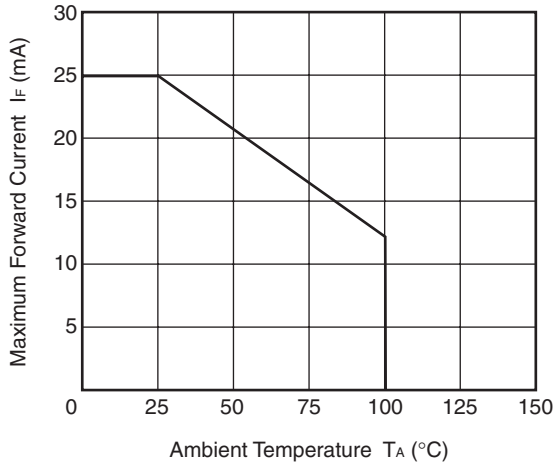
Remark C_L includes probe and stray wiring capacitance.

<R> USAGE CAUTIONS

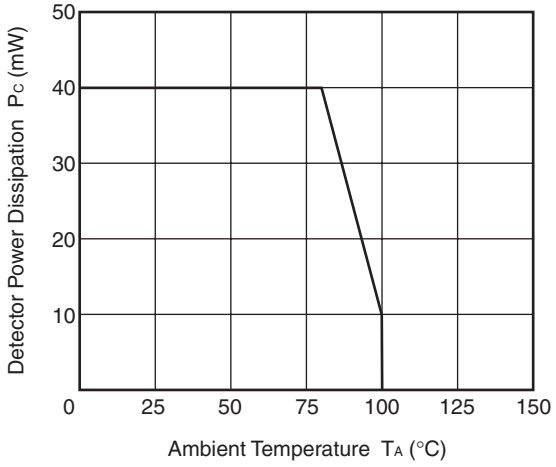
1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of 0.1 μF is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.

<R> **TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)**

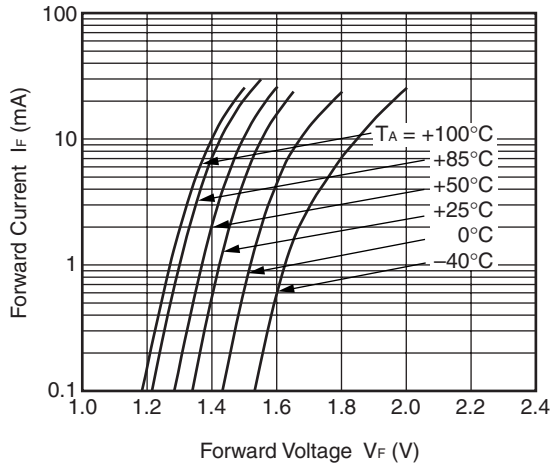
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



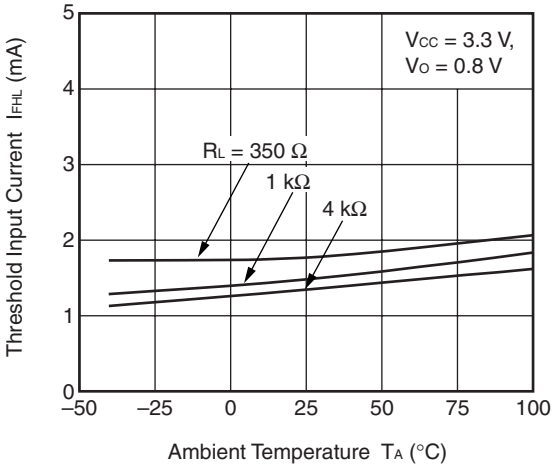
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



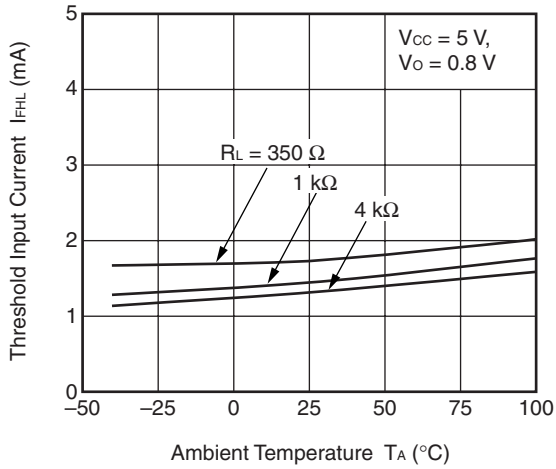
FORWARD CURRENT vs. FORWARD VOLTAGE



THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

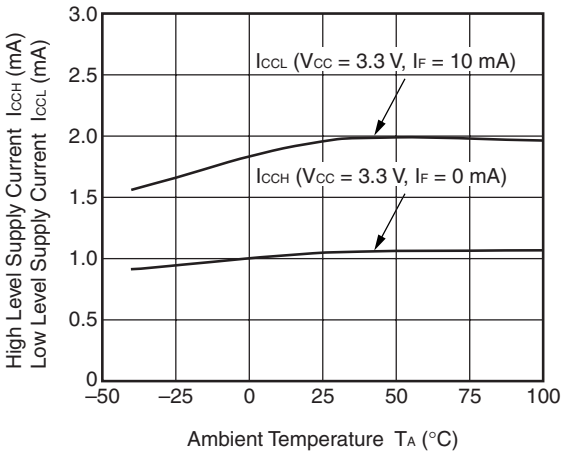


THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

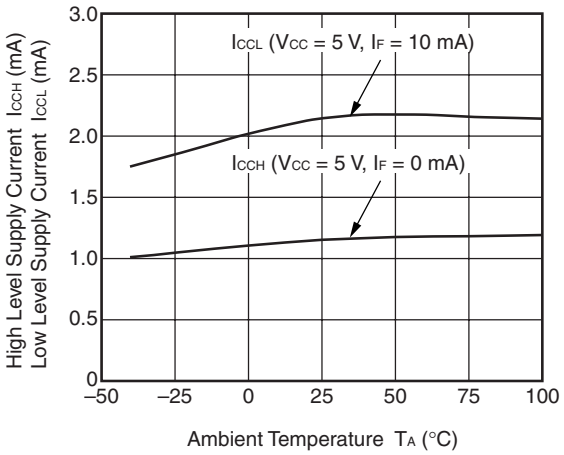


Remark The graphs indicate nominal characteristics.

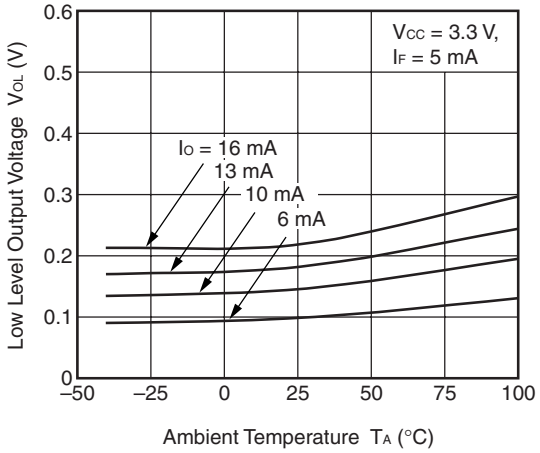
SUPPLY CURRENT vs.
AMBIENT TEMPERATURE



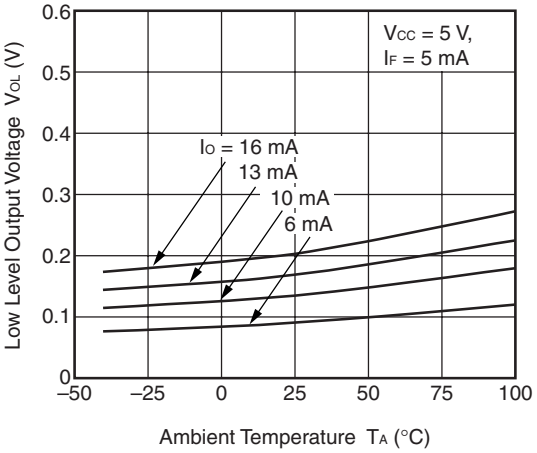
SUPPLY CURRENT vs.
AMBIENT TEMPERATURE



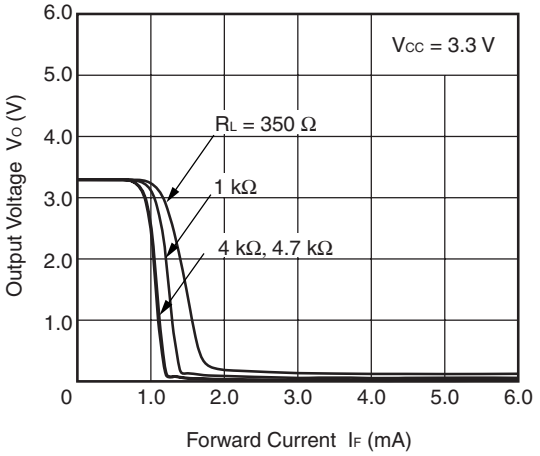
LOW LEVEL OUTPUT VOLTAGE vs.
AMBIENT TEMPERATURE



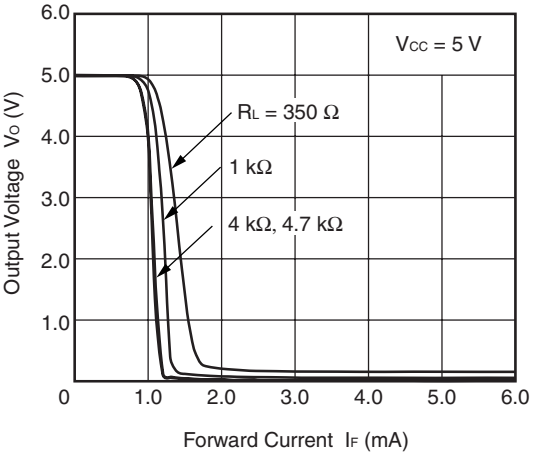
LOW LEVEL OUTPUT VOLTAGE vs.
AMBIENT TEMPERATURE



OUTPUT VOLTAGE vs. FORWARD CURRENT

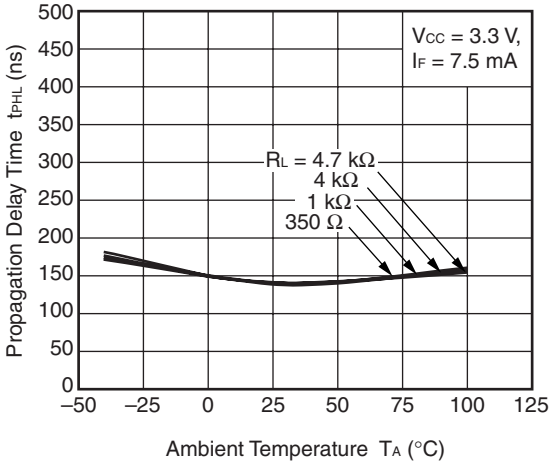


OUTPUT VOLTAGE vs. FORWARD CURRENT

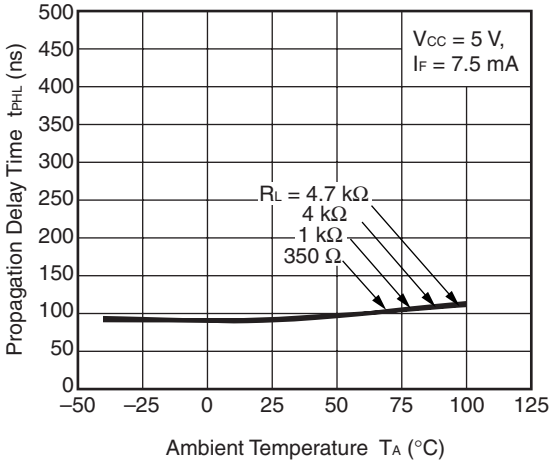


Remark The graphs indicate nominal characteristics.

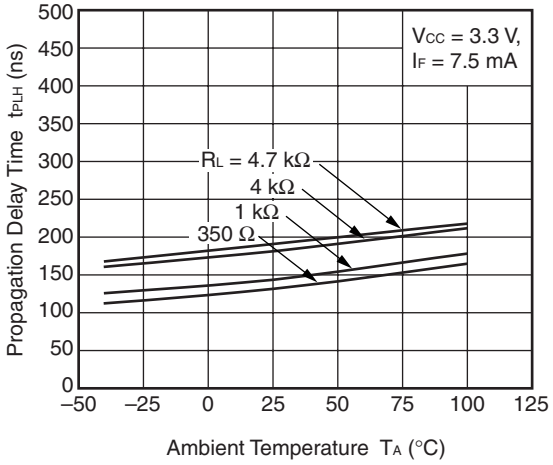
PROPAGATION DELAY TIME vs.
AMBIENT TEMPERATURE



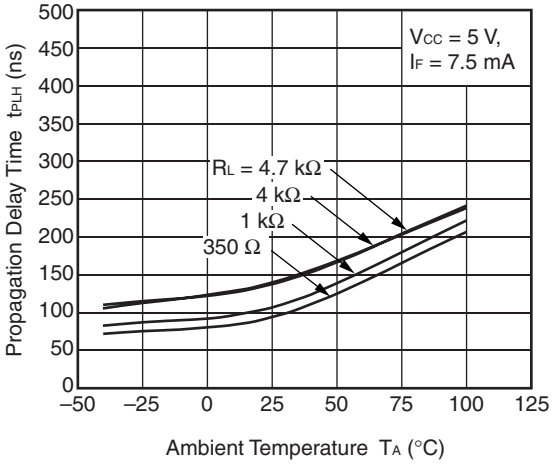
PROPAGATION DELAY TIME vs.
AMBIENT TEMPERATURE



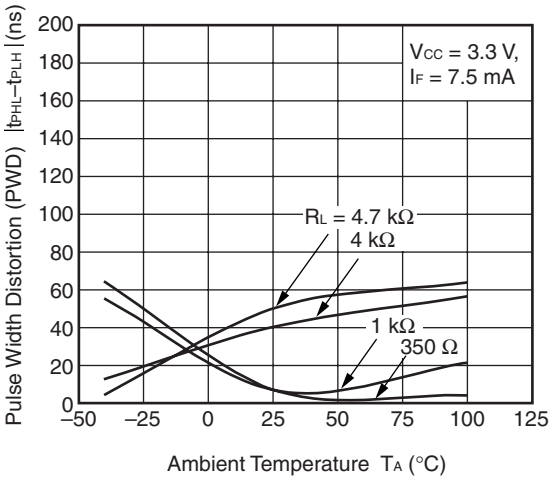
PROPAGATION DELAY TIME vs.
AMBIENT TEMPERATURE



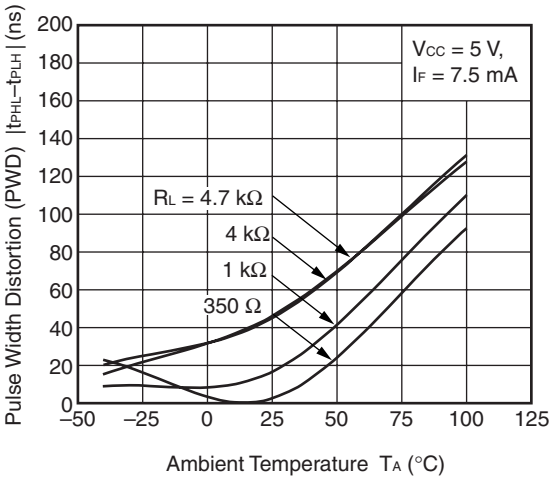
PROPAGATION DELAY TIME vs.
AMBIENT TEMPERATURE



PULSE WIDTH DISTORTION vs.
AMBIENT TEMPERATURE

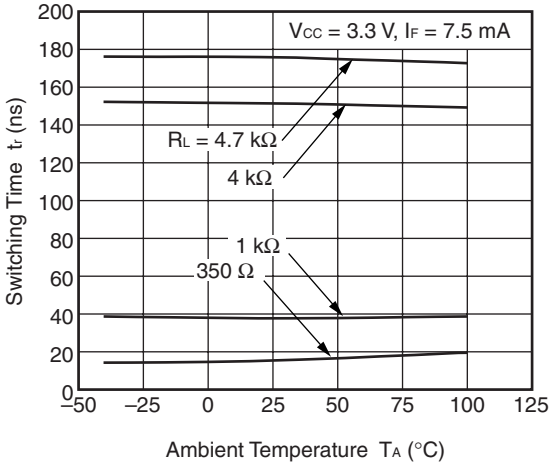


PULSE WIDTH DISTORTION vs.
AMBIENT TEMPERATURE

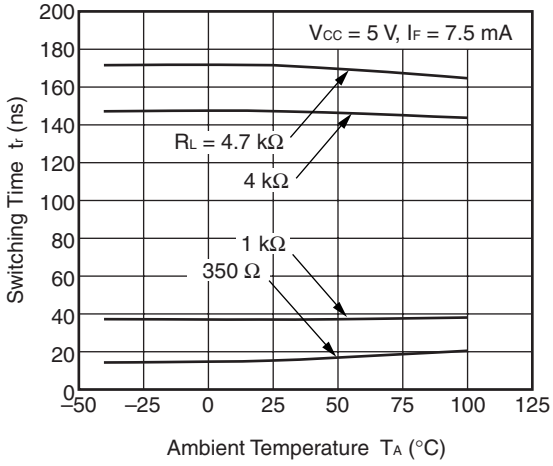


Remark The graphs indicate nominal characteristics.

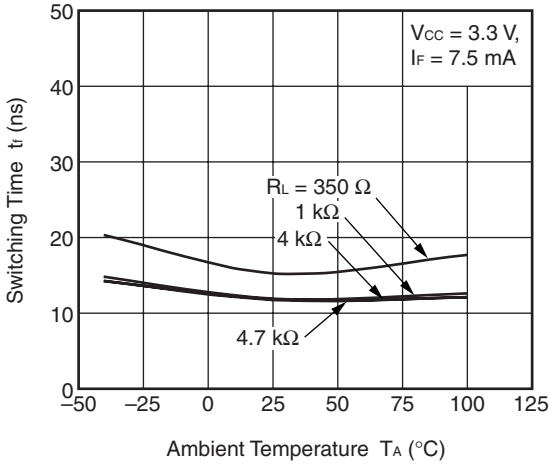
SWITCHING TIME vs.
AMBIENT TEMPERATURE



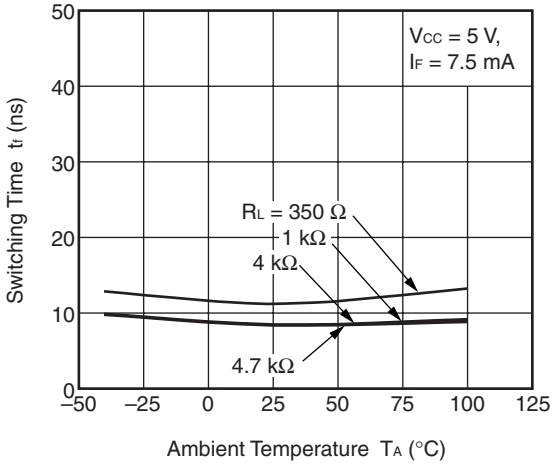
SWITCHING TIME vs.
AMBIENT TEMPERATURE



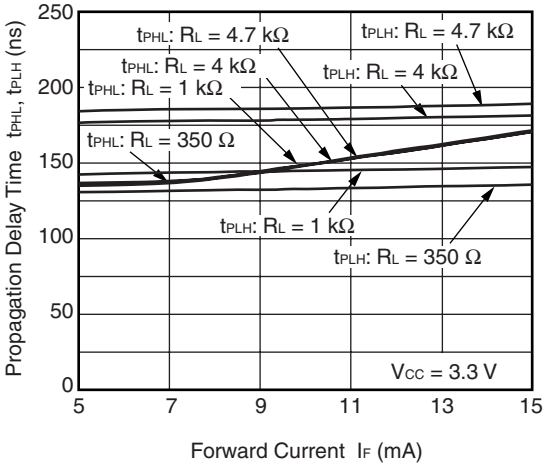
SWITCHING TIME vs.
AMBIENT TEMPERATURE



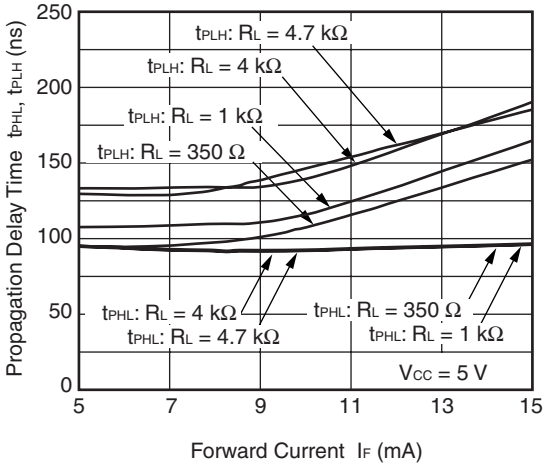
SWITCHING TIME vs.
AMBIENT TEMPERATURE



PROPAGATION DELAY TIME vs.
FORWARD CURRENT



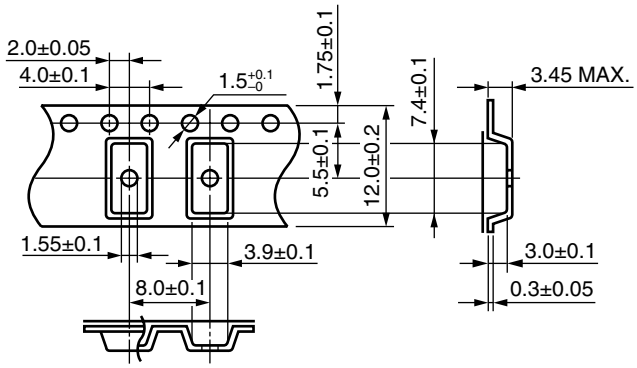
PROPAGATION DELAY TIME vs.
FORWARD CURRENT



Remark The graphs indicate nominal characteristics.

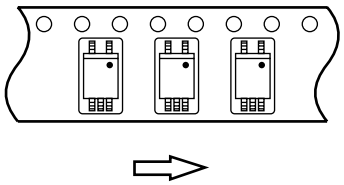
TAPING SPECIFICATIONS (UNIT: mm)

Outline and Dimensions (Tape)

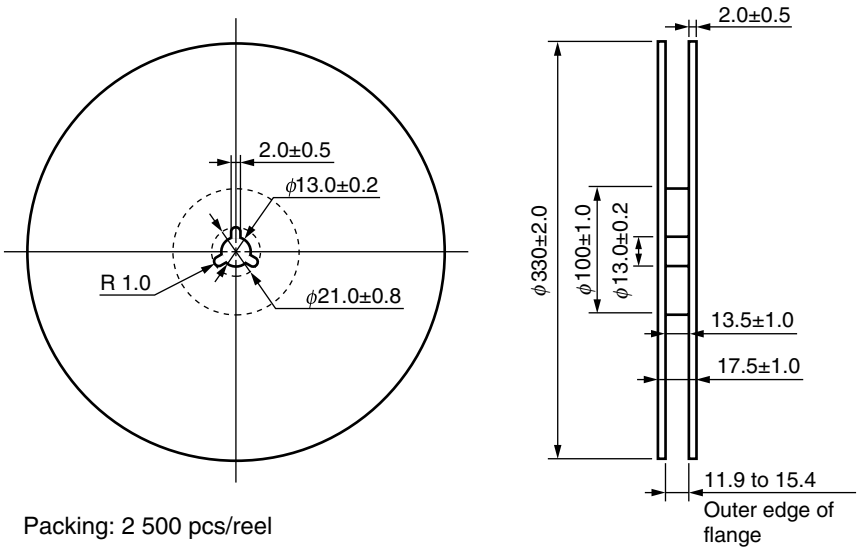


Tape Direction

PS9122-F3

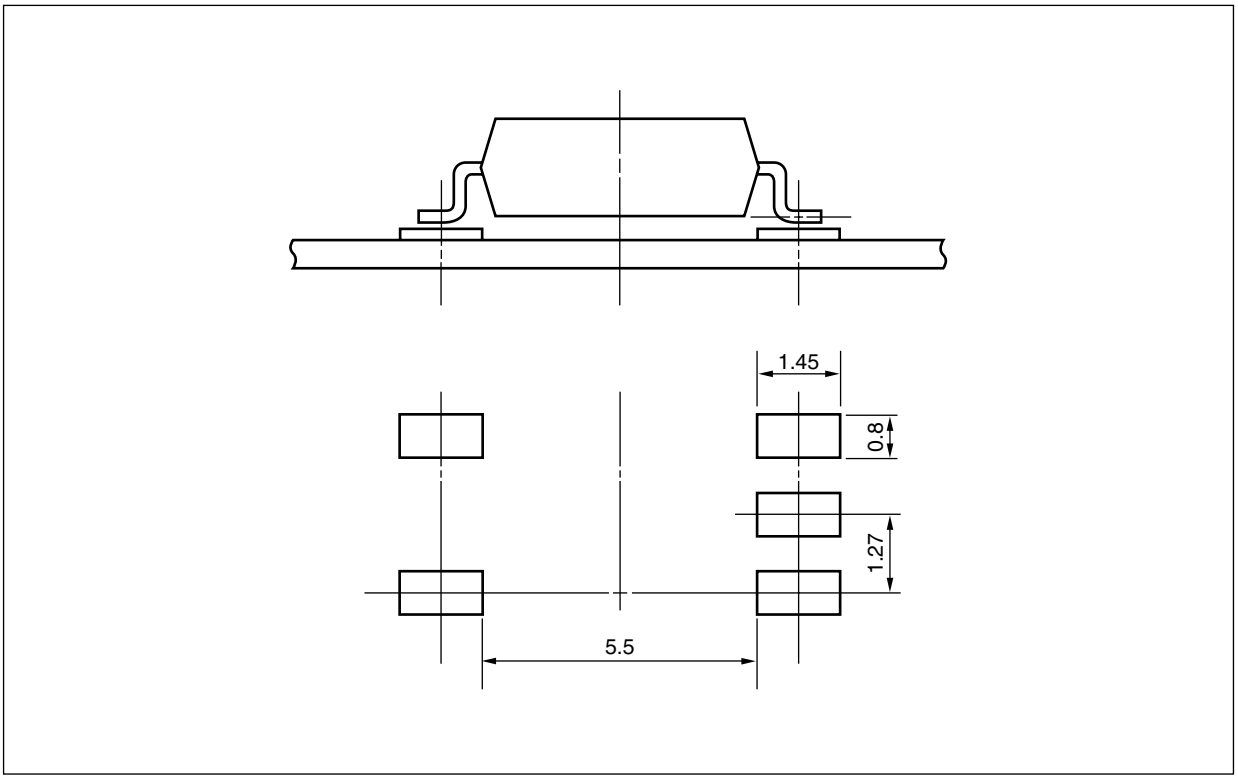


Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

<R> **RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**



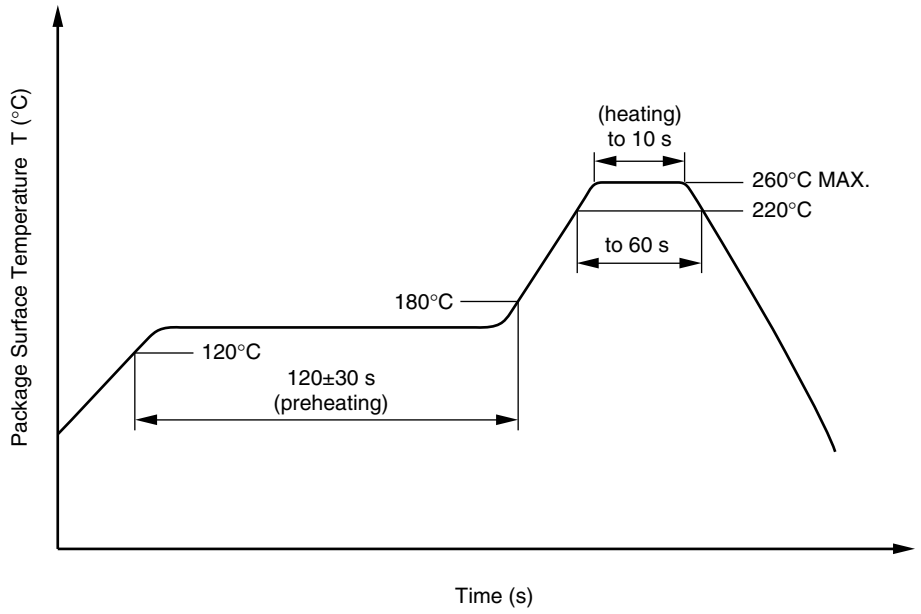
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature	260°C or below (package surface temperature)
• Time of peak reflow temperature	10 seconds or less
• Time of temperature higher than 220°C	60 seconds or less
• Time to preheat temperature from 120 to 180°C	120±30 s
• Number of reflows	Three
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature	260°C or below (molten solder temperature)
• Time	10 seconds or less
• Preheating conditions	120°C or below (package surface temperature)
• Number of times	One (Allowed to be dipped in solder including plastic mold portion.)
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature)	350°C or below
• Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}$, $P_d < 5$ pC	 U_{IORM} U_{pr}	 707 1 061	 V_{peak} V_{peak}
Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}$, $P_d < 5$ pC	U_{pr}	1 326	V_{peak}
Highest permissible overvoltage	U_{TR}	6 000	V_{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T_{stg}	–55 to +125	°C
Operating temperature range	T_A	–40 to +100	°C
Isolation resistance, minimum value V_{IO} = 500 V dc at T_A = 25°C V_{IO} = 500 V dc at T_A MAX. at least 100°C	 Ris MIN. Ris MIN.	 10^{12} 10^{11}	 Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I_F, Psi = 0) Power (output or total power dissipation) Isolation resistance V_{IO} = 500 V dc at T_A = Tsi	 Tsi Isi Psi Ris MIN.	 150 200 300 10^{9}	 °C mA mW Ω

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M8E0904E

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April 1st, 2010
Renesas Electronics Corporation

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